

N-channel 100 V, 2.3 mOhm MOSFET with enhanced SOA in LFPAK88

16 December 2022

Product data sheet

1. General description

N-channel enhancement mode MOSFET in a LFPAK88 package qualified to 175 °C. Part of Nexperia's "ASFETs for hotswap" portfolio, the PSMN2R3-100SSE delivers very low R_{DSon} and a very strong linear-mode (SOA) performance in a high-reliability copper-clip LFPAK88 package.

PSMN2R3-100SSE complements the latest "hot-swap" controllers - robust enough to withstand substantial inrush currents during turn-on, low R_{DSon} to minimize I²R losses and deliver optimum efficiency when turned fully ON.

2. Features and benefits

- Fully optimized Safe Operating Area (SOA) for superior linear mode operation
- Low R_{DSon} for low I²R conduction losses
- · LFPAK88 package for applications that demand the highest performance and reliability

3. Applications

- Hot swap
- Load switch
- Soft start
- E-fuse
- Telecommunication systems based on a 48 V backplane/supply rail

4. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	-	100	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>		-	-	255	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	-	341	W
Tj	junction temperature			-55	-	175	°C
Static chara	acteristics						
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 11		-	1.8	2.28	mΩ
Dynamic ch	naracteristics	·					
Q _{GD}	gate-drain charge	I _D = 25 A; V _{DS} = 50 V; V _{GS} = 10 V; Fig. 14; Fig. 13		8	27	62	nC
Q _{G(tot)}	total gate charge	I_D = 25 A; V_{DS} = 50 V; V_{GS} = 10 V; Fig. 13		80	161	242	nC
Avalanche	ruggedness						
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$ \begin{array}{l} I_{D} = 82 \; \text{A}; \; V_{sup} \leq \; 100 \; \text{V}; \; R_{GS} = 50 \; \Omega; \\ V_{GS} = 10 \; \text{V}; \; T_{j(\text{init})} = 25 \; ^{\circ}\text{C}; \; \text{unclamped}; \\ t_{p} = 137 \; \mu\text{s}; \; \underline{\text{Fig. 4}} \end{array} $	[1]	-	-	732	mJ

ne<mark>x</mark>peria

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Source-drain diode							
Qr	recovered charge	$I_{S} = 25 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ \text{V}_{DS} = 50 \text{ V}; \text{ Fig. 18}$	[2]	-	68	-	nC

[1] Protected by 100% test

[2] includes capacitive recovery

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		
2	S	source		D
3	S	source	0	
4	S	source		G(片云本)
mb	D	mounting base; connected to drain	LFPAK88 (SOT1235)	mbb076 S

6. Ordering information

Type number	Package					
	Name	Description	Version			
PSMN2R3-100SSE	LFPAK88	plastic, single-ended surface-mounted package (LFPAK88); 4 leads; 2 mm pitch; 8 mm x 8 mm x 1.6 mm body	SOT1235			

7. Marking

Table 4. Marking codes					
Type number	Marking code				
PSMN2R3-100SSE	X2E3S10S				

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	$25 \text{ °C} \le T_j \le 175 \text{ °C}$	-	100	V
V _{DGR}	drain-gate voltage	25 °C \leq T _j \leq 175 °C; R _{GS} = 20 kΩ	-	100	V
V _{GS}	gate-source voltage		-20	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>	-	341	W
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	-	255	А
		V _{GS} = 10 V; T _{mb} = 100 °C; <u>Fig. 2</u>	-	180	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^\circ C$; Fig. 3	-	1020	А
T _{stg}	storage temperature		-55	175	°C

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Symbol	Parameter	Conditions		Min	Max	Unit
Tj	junction temperature			-55	175	°C
T _{sld(M)}	peak soldering temperature			-	260	°C
Source-drai	n diode					
I _S	source current	T _{mb} = 25 °C		-	255	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$		-	1020	А
Avalanche r	uggedness					
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$ \begin{array}{l} I_{D} = 82 \; A; \; V_{sup} \leq \; 100 \; V; \; R_{GS} = 50 \; \Omega; \\ V_{GS} = 10 \; V; \; T_{j(init)} = 25 \; ^{\circ}C; \; unclamped; \\ t_{p} = 137 \; \mu s; \; \underline{Fig. \; 4} \end{array} $	[1]	-	732	mJ
I _{AS}	non-repetitive avalanche current	$V_{sup} \le 100 \text{ V}; V_{GS} = 10 \text{ V}; T_{j(init)} = 25 \text{ °C}; R_{GS} = 50 \Omega; Fig. 4$	[1]	-	82	A

[1] Protected by 100% test

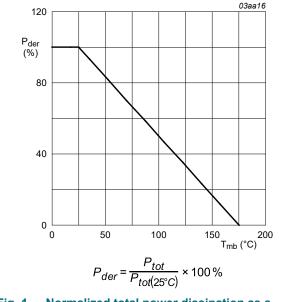
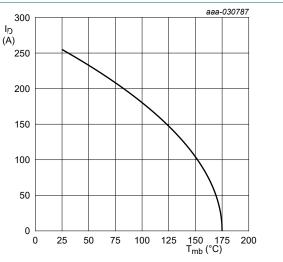


Fig. 1. Normalized total power dissipation as a function of mounting base temperature

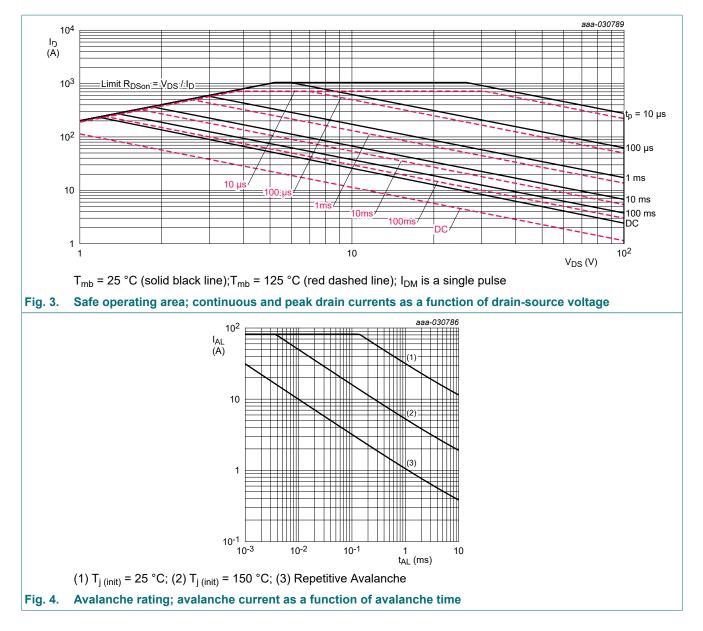


 $V_{GS} \ge 10 V$

(1) 255A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

Fig. 2. Continuous drain current as a function of mounting base temperature

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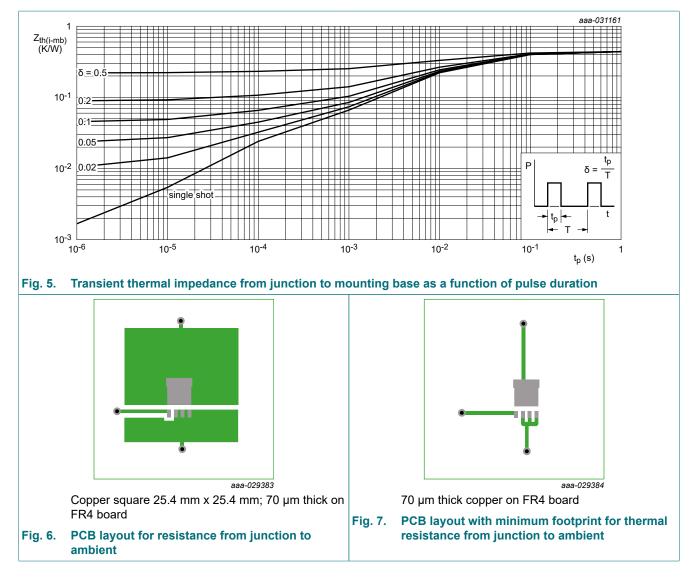


9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. <u>5</u>	-	0.2	0.44	K/W
R _{th(j-a)}	h(j-a) thermal resistance from junction to ambient	Fig. 6	-	35	-	K/W
		Fig. 7	-	70	-	K/W

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10. Characteristics

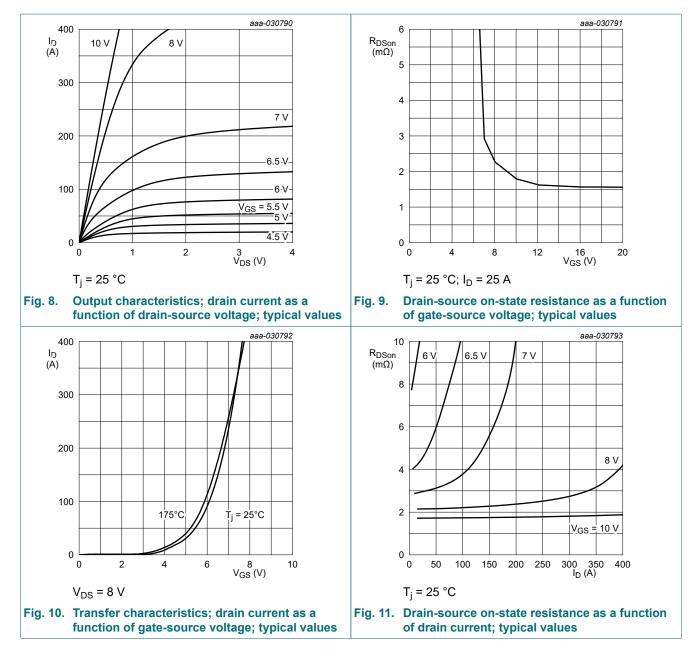
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static charac	teristics					
V _{(BR)DSS}	drain-source	I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C	100	-	-	V
	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = -55 °C	90	-	-	V
V _{GS(th)}	gate-source threshold voltage	I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 25 °C	2	2.6	3.6	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C	-	3	-	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C	-	1.6	-	V
$\Delta V_{GS(th)} / \Delta T$	gate-source threshold voltage variation with temperature	25 °C ≤ T _j ≤ 150 °C	-	-6.2	-	mV/K
I _{DSS}	drain leakage current	V _{DS} = 100 V; V _{GS} = 0 V; T _j = 25 °C	-	0.1	1	μA
		V _{DS} = 100 V; V _{GS} = 0 V; T _j = 125 °C	-	20	100	μA
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 11		-	1.8	2.28	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 100 °C; <u>Fig. 12</u>		-	2.9	3.6	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C; <u>Fig. 12</u>		-	3.7	5.2	mΩ
R _G	gate resistance	f = 1 MHz; T _j = 25 °C		0.7	1.4	2.8	Ω
Dynamic ch	aracteristics						
Q _{G(tot)}	total gate charge	I _D = 25 A; V _{DS} = 50 V; V _{GS} = 10 V; Fig. 13		80	161	242	nC
		$I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}; \frac{\text{Fig. 14}}{\text{Fig. 13}};$		-	84	-	nC
Q _{GS}	gate-source charge	I _D = 25 A; V _{DS} = 50 V; V _{GS} = 10 V;		32	54	76	nC
Q _{GS(th)}	pre-threshold gate- source charge	Fig. 14; Fig. 13		-	34	-	nC
Q _{GS(th-pl)}	post-threshold gate- source charge			-	20	-	nC
Q _{GD}	gate-drain charge			8	27	62	nC
V _{GS(pl)}	gate-source plateau voltage	I _D = 25 A; V _{DS} = 50 V; <u>Fig. 14</u> ; <u>Fig. 13</u>		-	4.7	-	V
C _{iss}	input capacitance	V_{DS} = 50 V; V_{GS} = 0 V; f = 0.5 MHz;		7380	12300	17200	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 16</u>		1600	2670	4300	pF
C _{rss}	reverse transfer capacitance	_		4	36	94	pF
t _{d(on)}	turn-on delay time	V_{DS} = 50 V; R _L = 2 Ω; V _{GS} = 10 V;		-	41	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega$		-	41	-	ns
t _{d(off)}	turn-off delay time			-	88	-	ns
t _f	fall time			-	54	-	ns
Source-drai	n diode						
V _{SD}	source-drain voltage	$I_{S} = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_{j} = 25 \text{ °C}; Fig. 17$		-	0.8	1	V
t _{rr}	reverse recovery time	$I_{S} = 25 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$		-	56	-	ns
Qr	recovered charge	V _{DS} = 50 V; <u>Fig. 18</u>	[1]	-	68	-	nC

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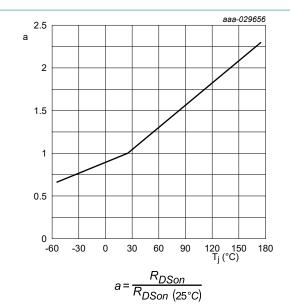
[1] includes capacitive recovery

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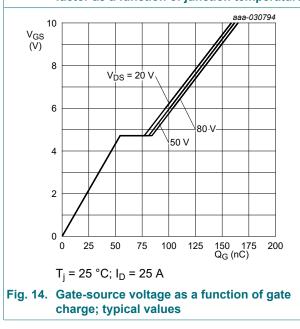


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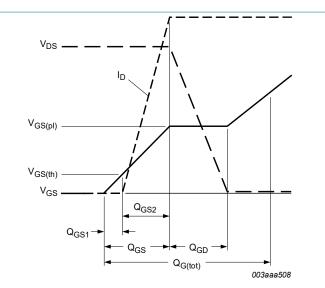
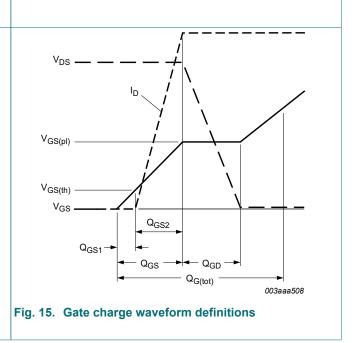
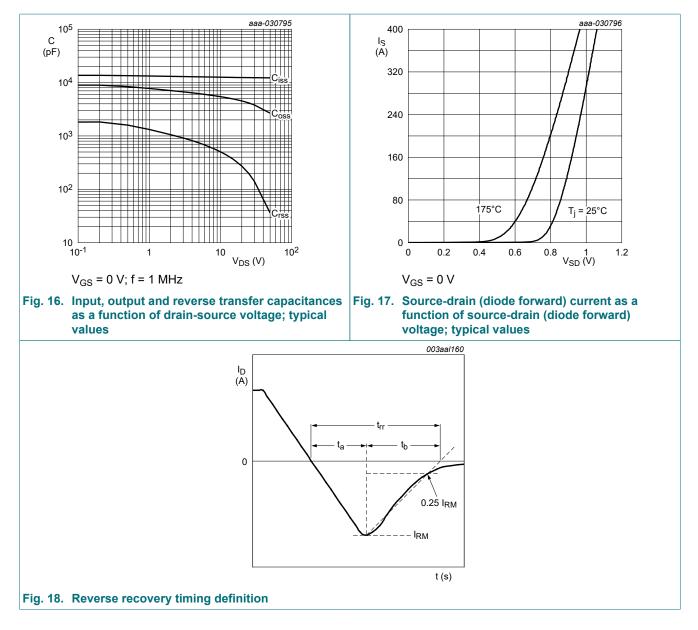


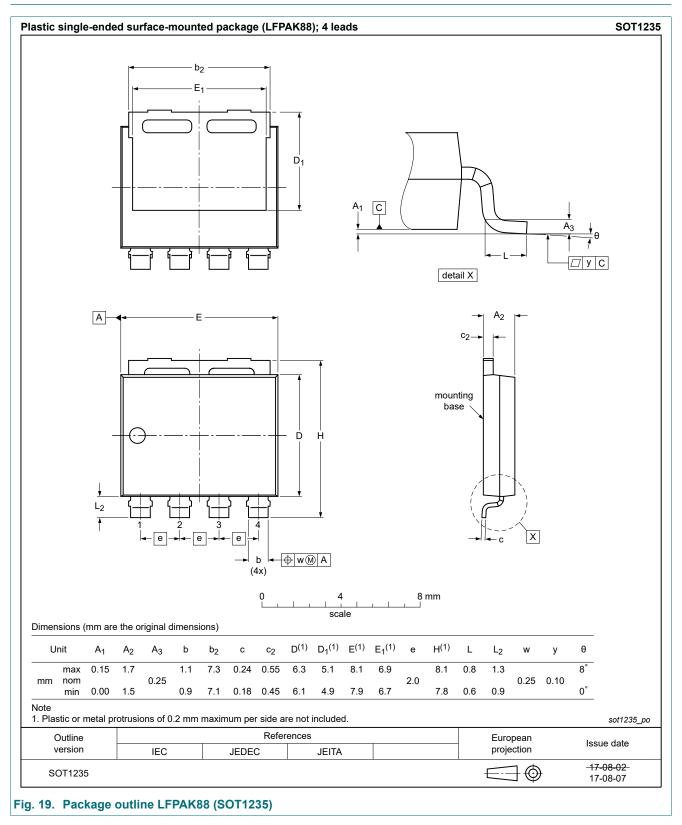
Fig. 13. Gate charge waveform definitions



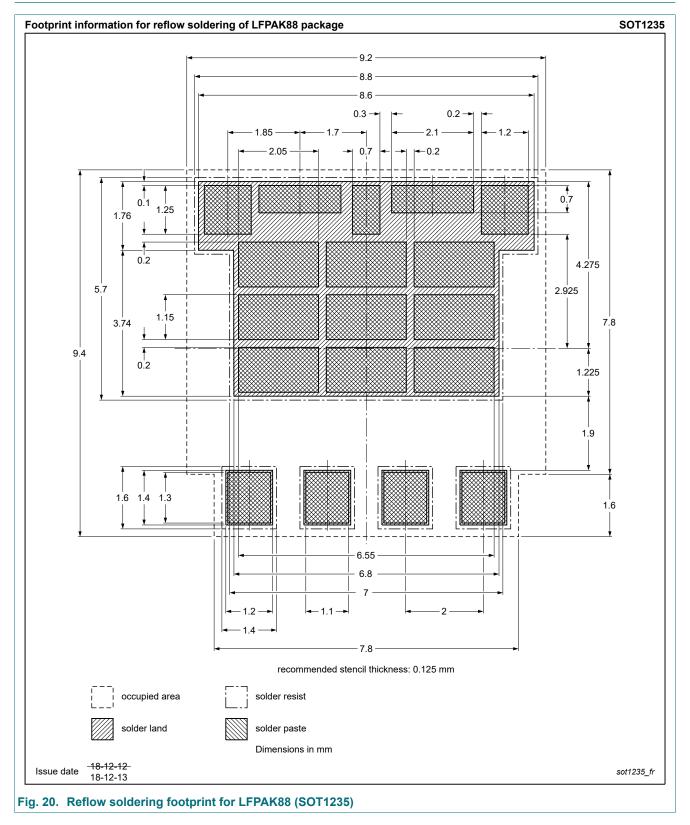
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11. Package outline



12. Soldering



13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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